

## PRELIMINARY

MITSUBISHI SEMICONDUCTOR <GaAs FET>

**MGF1951A**

Medium Power Microwave MESFET

### DESCRIPTION

The MGF1951A is a 20mW MESFET for S- to Ku-band driver amplifiers and oscillators.

Its lead-less ceramic package assures minimum parasitics.



### FEATURES

- High Gain and High Output Power  
 $G_{LP}=9\text{dB}$ ,  $P_{1\text{dB}}=13\text{dBm}$  (typ) @  $f=12\text{GHz}$
- Leadless Ceramic Package

### APPLICATION

S- to Ku-Band Driver Amplifiers and Oscillators

### QUALITY

General Grade

### ORDERING INFORMATION

Part Number	Quantity	Supply Form
MGF1951A-01	3.000 pcs/reel	Tape & Reel

### ABSOLUTE MAXIMUM RATINGS ( $T_a=+25^\circ\text{C}$ )

Symbol	Parameter	Rating	Unit
$V_{GDO}$	Gate to Drain Voltage	-8	V
$V_{GS0}$	Gate to Source Voltage	-8	V
$I_D$	Drain Current	120	mA
$P_T$	Total Power Dissipation	300	mW
$T_{ch}$	Channel Temperature	125	$^\circ\text{C}$
$T_{stg}$	Storage Temperature	-65 to +125	$^\circ\text{C}$

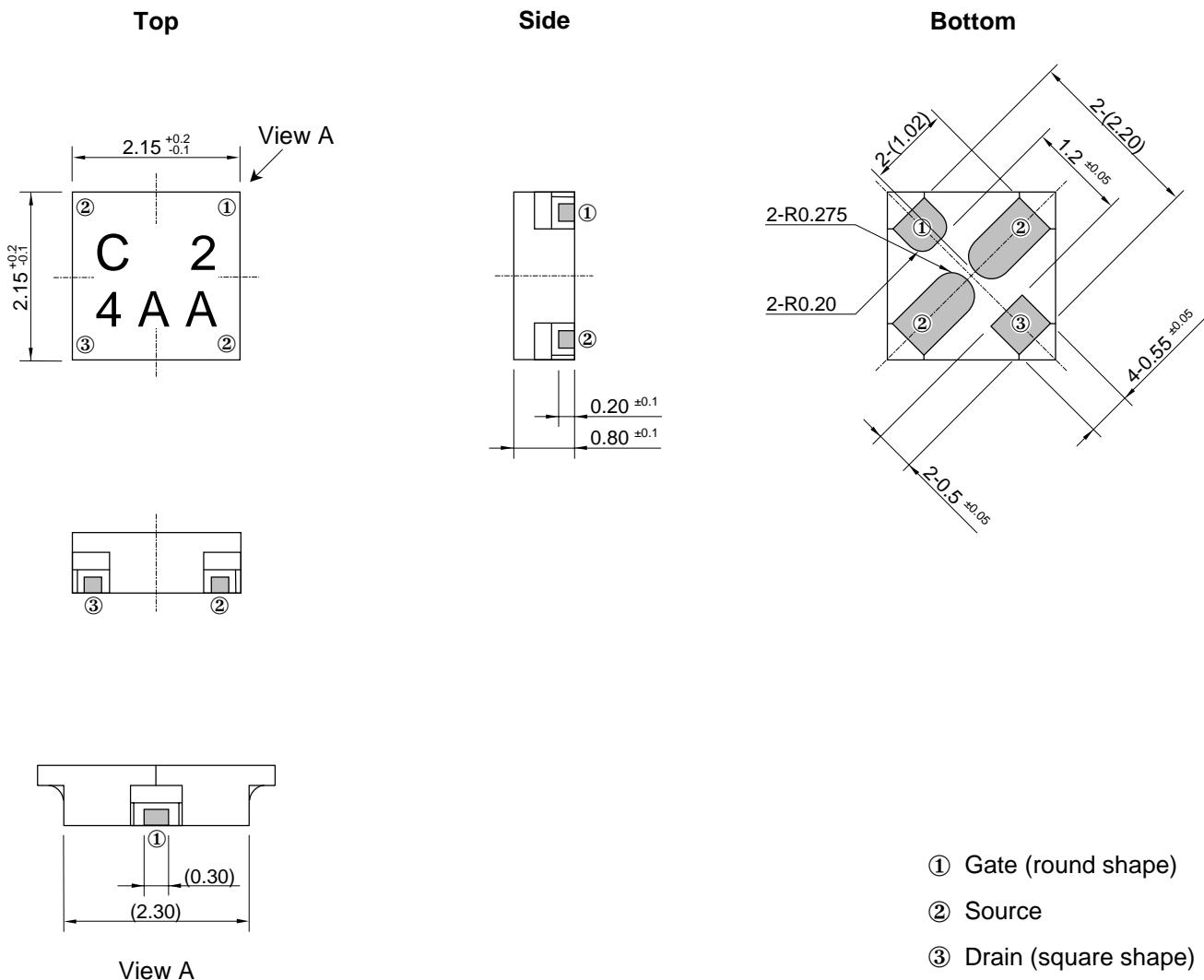
Keep Safety first in your circuit designs!

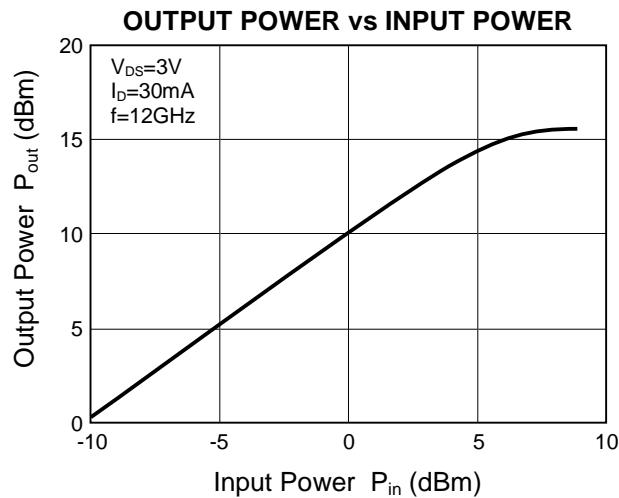
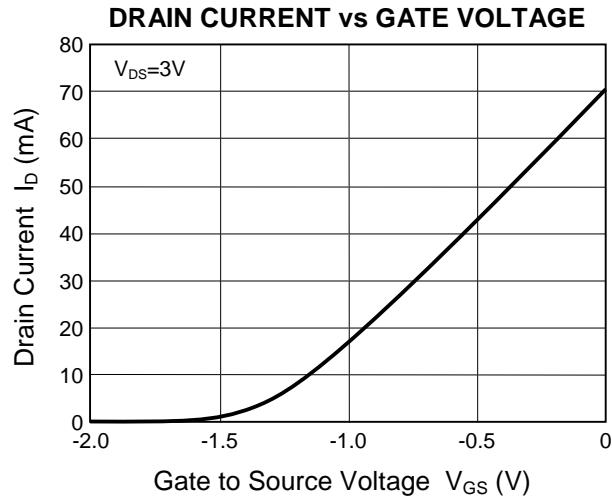
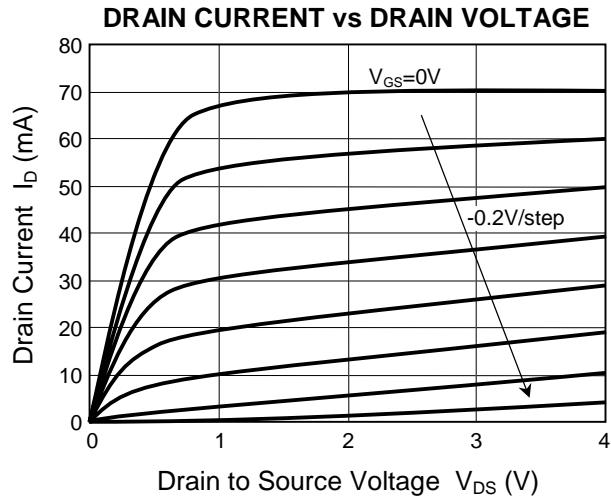
Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measure such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

### ELECTRICAL CHARACTERISTICS ( $T_a=+25^\circ\text{C}$ )

Symbol	Parameter	Test Conditions	MIN	TYP	MAX	Unit
$V_{(BR)GDO}$	Gate to Drain Breakdown Voltage	$I_G=-30\mu\text{A}$	-8	-15	—	V
$I_{DSS}$	Saturated Drain Current	$V_{DS}=3\text{V}$ , $V_{GS}=0\text{V}$	35	60	120	mA
$V_{GS(\text{off})}$	Gate to Source Cut-off Voltage	$V_{DS}=3\text{V}$ , $I_D=300\mu\text{A}$	-0.3	-1.4	-3.5	V
$P_{1\text{dB}}$	Output Power at 1dB Gain Compression	$V_{DS}=3\text{V}$ , $I_D=30\text{mA}$ , $f=12\text{GHz}$	11	13	—	dBm
$G_{LP}$	Linear Power Gain	$V_{DS}=3\text{V}$ , $I_D=30\text{mA}$ , $P_{in}=-5\text{dBm}$ , $f=12\text{GHz}$	7	9	—	dB

## OUTLINE DRAWING (mm)



TYPICAL CHARACTERISTICS ( $T_a=+25^\circ\text{C}$ )

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**S PARAMETERS** ( $V_{DS}=3V$ ,  $I_D=30mA$ ,  $T_a=+25^\circ C$ )

f (GHz)	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>		K	MAG/MSG (dB)
	Mag	Ang	Mag	Ang	Mag	Ang	Mag	Ang		
1	0.984	-17.7	4.239	163.2	0.016	78.2	0.581	-11.3	0.18	24.3
2	0.946	-38.6	4.103	144.3	0.031	64.3	0.565	-26.2	0.32	21.3
3	0.906	-52.5	3.914	131.2	0.043	54.3	0.548	-34.3	0.43	19.6
4	0.857	-71.1	3.710	115.9	0.054	44.2	0.518	-45.5	0.53	18.4
5	0.811	-85.3	3.445	103.3	0.061	35.6	0.509	-54.9	0.64	17.5
6	0.771	-97.4	3.197	92.5	0.065	29.6	0.500	-61.4	0.76	16.9
7	0.736	-109.8	2.984	81.7	0.069	23.7	0.502	-66.9	0.86	16.4
8	0.710	-121.6	2.847	70.7	0.071	19.0	0.507	-72.1	0.93	16.0
9	0.679	-133.6	2.737	60.4	0.075	15.1	0.509	-75.9	0.99	15.6
10	0.645	-146.3	2.659	50.1	0.083	11.3	0.513	-79.6	0.99	15.1
11	0.594	-159.8	2.600	39.5	0.089	2.6	0.496	-84.2	1.09	12.8
12	0.549	-175.7	2.570	28.4	0.091	-2.7	0.472	-87.2	1.19	11.9
13	0.508	165.8	2.532	16.2	0.095	-9.0	0.443	-91.4	1.27	11.1
14	0.481	142.3	2.480	2.5	0.100	-18.0	0.399	-96.7	1.34	10.5
15	0.472	116.9	2.378	-10.9	0.101	-26.7	0.342	-101.7	1.45	9.7
16	0.508	92.7	2.289	-23.8	0.103	-34.7	0.279	-107.6	1.47	9.4
17	0.573	70.4	2.160	-37.5	0.105	-42.9	0.211	-112.1	1.44	9.2
18	0.646	52.2	1.975	-51.6	0.103	-50.4	0.135	-115.3	1.44	8.9

